

HANAREY CSE4340 Product Data Sheet

Sep 2024

Hanarey CSE4340 is designed for PCB encapsulation of electronic products. It has excellent adhesion to a wide variety of substrates including glass, many plastics, and most metals. Hanarey CSE4340 has good flexibility and enhances load bearing & shock absorbing characteristics of the bond area. The material cures upon exposure to light. Its ability to UV cure tack free in seconds enables faster processing, greater output, and lower processing costs.

UNCURED PROPERTIES *

Property	Value	Test Method
Chemical Class	Acrylated Urethane	N/A
Appearance	Bone-white to Beige Translucent Paste	N/A
Density, g/ml	1.10	ASTM D1875
Viscosity, cP	35,000~70,000 (3.0 s ⁻¹)	HSTM 252 †
Shelf Life from Date of Manufacture	270 days	N/A

OTHER PROPERTIES *

Property	Value	Test Method
Boiling Water Absorption, % (2 h)	3.60	ASTM D570
Water Absorption, % (25°C, 24 h)	2.11	ASTM D570
Linear Shrinkage, %	0.34	ASTM D2566
Glass Transition Tg, °C	81	ASTM D5418

CURED MECHANICAL PROPERTIES *

Property	Value	Test Method
Hardness	D50~D75	ASTM D2240
Tensile at Break, MPa	16.34	ASTM D638
Elongation at Break, %	157	ASTM D638
Modulus of Elasticity, MPa	149.3	ASTM D638
CTE _{α1} , μm/m/°C	172	ASTM E831
CTE _{α2} , μm/m/°C	193	ASTM E831

* Not Specifications
 N/A Not Applicable
 † Measured after UV cure only
 # Cured by Dymax 5000-EC (all spectrum), 120 mW/cm² intensity, 30 s

ADHESION *

Substrate	Shear Strength #
PC / PC	26.35 MPa
PC / SS	9.88 MPa
PC / Glass	9.02 MPa
PC / PCB	12.89 MPa
PC / AL	12.51 MPa
PC / PMMA	13.23 MPa
PC / PA9T	7.86 MPa

TRANSPORTATION, STORAGE, AND SHELF LIFE

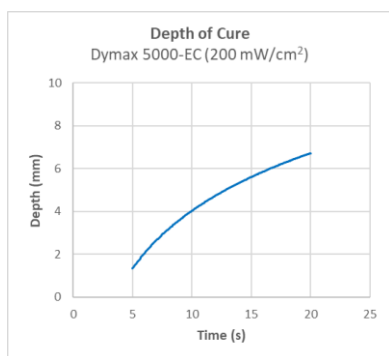
Do not crush and throw to avoid leakage during transportation. It is verified that the product's exposure to ambient temperature for a short time during transportation will not affect its performance. Store the material in a low-humidity, cool, and dark place when not in use. This product may polymerize upon prolonged exposure to ambient and artificial light as well as moisture. This material shelf life is noted on page 1 of this document when stored between 10°C (50°F) and 35°C (95°F) in the original, unopened container.

CLEAN UP

Uncured Hanarey materials may be removed from dispensing components and parts with non-alcoholic solvents. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods such as ultrasonic bath, water, jet, vacuum tweezers, air knife, and/or warming to aid in the removal.

CURING GUIDELINE

The graph below shows the increase in depth of cure as a function of exposure time at Dymax 5000-EC 200 mW/cm². These depths are only due to light cure.



Full cure is best determined empirically by curing at different times and intensities and measuring the corresponding change in cured properties such as tackiness, adhesion, hardness, etc. Full cure is defined as the point at which more energy exposure no longer improves cured properties. Higher intensities or longer cures (up to 5x) generally will not degrade Hanarey light-curable adhesives.

Hanarey recommends that customers employ a safety factor by curing longer and/or at higher intensities than required for a full cure. Although Hanarey Application Engineering can provide technical support and assist with process development, each customer ultimately must determine and qualify the appropriate curing parameters required for their unique application.

GENERAL INFORMATION

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from the skin with soap and water. Never use organic solvents to remove material from the skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

The data provided in this document are based on historical testing that Hanarey performed under laboratory conditions as they existed at that time and are for informational purposes only. The data are neither specifications nor guarantees of future performance in a particular application. Hanarey does not guarantee that this product's properties are suitable for the user's intended purpose. The contents of this document are subject to change. Unless specifically agreed to in writing, Hanarey shall have no obligation to notify the user about any change to its content.

Data Collected: Sep 2024

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